

Data Sheet N2679, REV.-

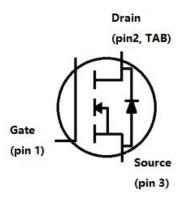
## S2M0160120D



## S2M0160120D 1200V SIC POWER MOSFET



#### **Circuit Diagram**



#### Description

S2M0160120D is single SiC Power MOSFET packaged in TO-247AD case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0160120D is ideal for energy sensitive, high frequency applications in challenging environments.

#### Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 175mQ .
- Fast switching speed and low switching losses.
- Very fast and robust intrinsic body diode.
- Process of non-bright Tin electroplatin

#### Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

#### Characteristics Symbol Condition Max. Units 1200 V Drain Source Voltage VDSS $V_{GS}$ = 0V, $I_{DS}$ = 100uA, $T_{C}$ = 25°C Gate Source Voltage V<sub>GSS</sub> Tc = 25 ° C, Absolute maximum values, AC -10 to +25 V (f>1Hz) Gate Source Voltage VGSOP T<sub>c</sub> = 25°C Recommended Operational Values -5 to +20 V **Continuous Drain Current** $V_{GS} = 20V, T_C = 25^{\circ}C$ $I_D$ 17 А $I_D$ $V_{GS} = 20V, T_{C} = 100^{\circ}C$ 12 А Tc=25°C 40 Pulsed Drain Current А ID,pulse T<sub>c</sub>=25°C W Power Dissipation $P_{D}$ 130

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#### Maximum Ratings(T=25°C unless otherwise specified)



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## Electrical Characteristics (T=25 $^{\circ}$ C unless otherwise specified)

| Characteristics                 | Symbol               | Condition  | Min.   | Тур. | Max. | Unit<br>s |  |
|---------------------------------|----------------------|--|--------|------|------|-----------|--|
| Drain Source Breakdown Voltage  | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 100 uA   | 1200   |      |      | V         |  |
|                                 | V <sub>GS(th)</sub>  | $V_{DS} = V_{GS}, I_D = 2.5 \text{ mA}$  | 2.0    | 2.8  | 4    | V         |  |
| Gate Threshold Voltage          |                      | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 2.5 mA, T <sub>J</sub> = 175 °C                                 |        | 1.9  |      | V         |  |
| Zero Gate Voltage Drain Current | IDSS                 | V <sub>DS</sub> = 1200 V, V <sub>GS</sub> = 0 V  |        | 1    | 100  | uA        |  |
| Gate Source Leakage Current     | I <sub>GSS</sub>     | V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V  |        |      | 250  | nA        |  |
| Drain Source On-State           | Dest                 | V <sub>GS</sub> = 20 V, I <sub>D</sub> = 10 A  |        | 175  | 196  | mΩ        |  |
| Resistance                      | R <sub>DS(on)</sub>  | $V_{GS}$ = 20 V, I <sub>D</sub> = 10 A, T <sub>J</sub> = 175 °C  |        | 300  |      | mΩ        |  |
| Tananakutana                    |                      | V <sub>DS</sub> = 20 V, I <sub>D</sub> = 10 A  |        | 3.3  |      | S         |  |
| Transconductance                | gfs                  | V <sub>DS</sub> = 20 V, I <sub>D</sub> = 10 A, T <sub>J</sub> = 175 °C   | °C 3.4 |      | S    |           |  |
| Input Capacitance               | C <sub>ISS</sub>     | V <sub>GS</sub> = 0 V,   |        | 513  |      |           |  |
| Output Capacitance              | Coss                 | $V_{DS} = 1000 V$  |        | 35.6 |      | pF        |  |
| Reverse Transfer Capacitance    | C <sub>RSS</sub>     | V <sub>AC</sub> = 25 mV<br>f = 100 kHz   |        | 2.59 |      |           |  |
| Coss Stored Energy              | Eoss                 |  |        | 20.5 |      | uJ        |  |
| Turn-On Switching Energy        | E <sub>ON</sub>      | $V_{DS}$ = 800 V, $V_{GS}$ = -5/+20 V  |        | 90.3 |      | -         |  |
| Turn-Off Switching Energy       | E <sub>OFF</sub>     | ID =10 A, RG(ext)=2.5 Ω  |        | 54.5 |      | uJ        |  |
| Turn-On Delay Time              | $t_{d(on)}$          |  |        | 3.5  |      |           |  |
| Rise Time                       | tr                   | V <sub>DS</sub> = 800 V. V <sub>GS</sub> = -5/20 V   |        | 11.8 |      |           |  |
| Turn-Off Delay Time             | $t_{d(off)}$         | $V_{DS} = 800 \text{ V}, V_{GS} = -5/20 \text{ V}$<br>$I_D = 10 \text{ A}, R_{G(ext)} = 2.5 \Omega, R_L = 80 \Omega$ |        | 7.0  |      | ns        |  |
| Fall Time                       | t <sub>f</sub>       |  |        | 13.4 |      |           |  |
| Internal Gate Resistance        | R <sub>G(int)</sub>  | f = 1 MHz, VAC = 25 mV, D-S short  |        | 6.5  |      | Ω         |  |
| Gate to Source Charge           | Q <sub>gs</sub>      | V <sub>DS</sub> = 800 V, V <sub>GS</sub> = -5/20 V 7   |        | 7.7  |      |           |  |
| Gate to Drain Charge            | $Q_{gd}$             | I <sub>D</sub> = 10 A  |        | 8.2  |      | nC        |  |
| Total Gate Charge               | Qg                   |  |        | 26.5 |      |           |  |



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#### **Reverse Diode Characteristics:**

| Characteristics                  | Symbol          | Condition  | Тур. | Max. | Units |
|----------------------------------|-----------------|--|------|------|-------|
| Diode Forward Voltage            | V <sub>SD</sub> | V <sub>GS</sub> = -5 V, I <sub>SD</sub> = 5 A                          | 3.3  |      | V     |
|                                  | V <sub>SD</sub> | V <sub>GS</sub> = -5 V, I <sub>SD</sub> = 5 A, T <sub>J</sub> = 175 °C | 2.9  |      | V     |
| Continuous Diode Forward Current | ls              | V <sub>GS</sub> = -5 ∨, T <sub>C</sub> = 25 ℃                          | 20   |      | А     |
| Reverse Recovery Time            | t <sub>rr</sub> | V <sub>GS</sub> = -5 V, I <sub>SD</sub> = 10 A, T <sub>J</sub> = 25 °C | 6.6  |      | ns    |
| Reverse Recovery Charge          | Qrr             | V <sub>R</sub> = 800 V   | 0.04 |      | uC    |
| Peak Reverse Recovery Current    | I <sub>mm</sub> | dif/dt= 2533 A/µs  | 11   |      | А     |

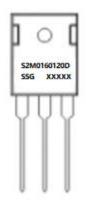
#### **Thermal-Mechanical Specifications:**

| Characteristics                                | Symbol              | Condition    | Specification | Units |
|--|---------------------|--------------|---------------|-------|
| Junction Temperature                           | TJ                  | -            | -55 to +175   | °C    |
| Storage Temperature                            | T <sub>stg</sub>    | -            | -55 to +175   | °C    |
| Typical Thermal Resistance Junction to Case    | $R_{	ext{	heta}JC}$ | DC operation | 1.15          | °C/W  |
| Maximum Thermal Resistance Junction to Ambient | R <sub>0JA</sub>    |              | 56            | °C/W  |

#### **Ordering Information:**

| Device      | Package  | Shipping   |
|-------------|----------|------------|
| S2M0160120D | TO-247AD | 30pcs/tube |

## **Marking Diagram**



#### Where XXXXX is YYWWL

S2M = Device Type

0160 =  $R_{DS}(on)$ 120 = Reverse Voltage

= Reverse Voltage (1200V) = Package

- D = Pac SSG = SSG
- YY = Year

L

WW = Week

= Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

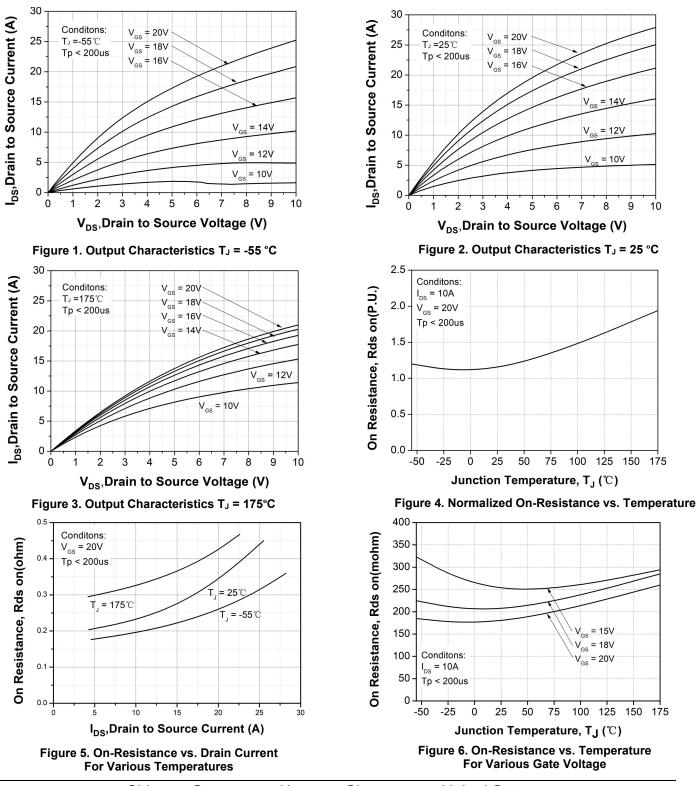
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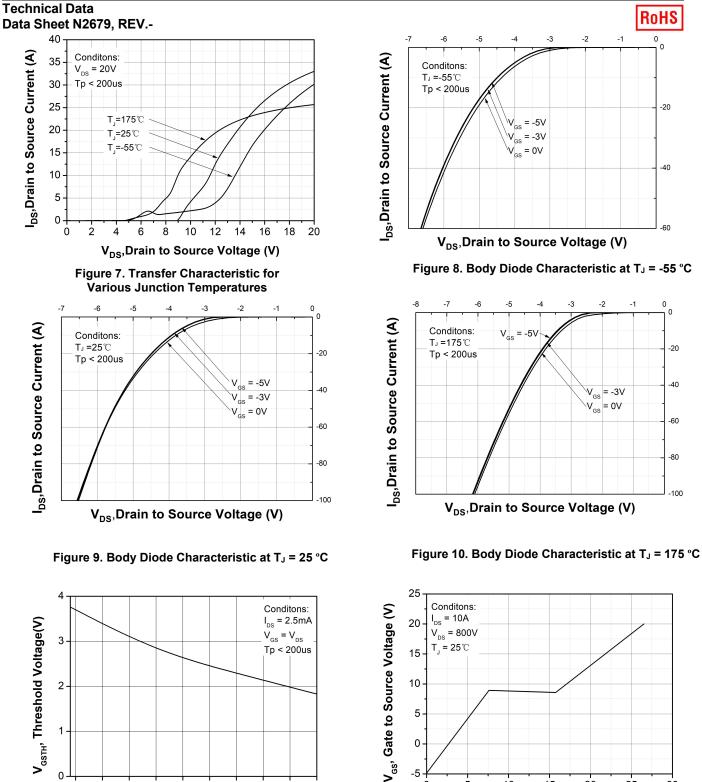
#### **Ratings and Characteristics Curves**



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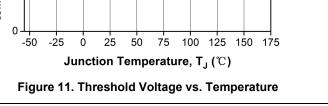


Figure 12. Gate Charge Characteristic

20

15

Q<sub>c</sub>, Gate Charge (nC)

25

30

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0

-5

0

5

10



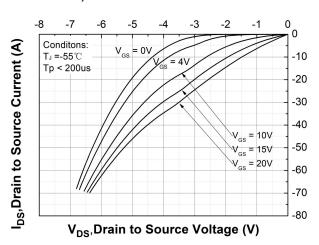
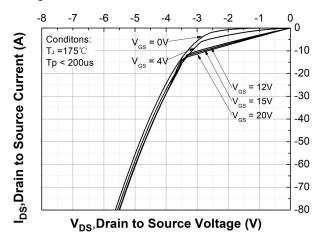
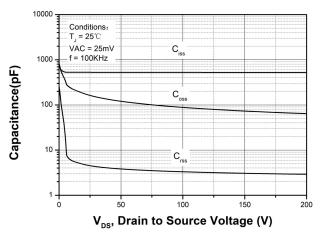
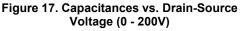


Figure 13. 3rd Quadrant Characteristic at T<sub>J</sub> = -55 °C









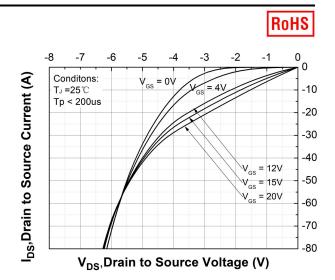


Figure 14. 3rd Quadrant Characteristic at T<sub>J</sub> = 25 °C

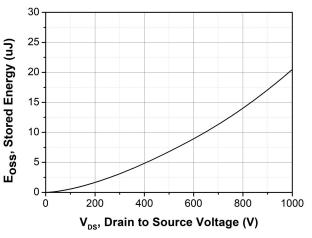


Figure 16. Output Capacitor Stored Energy

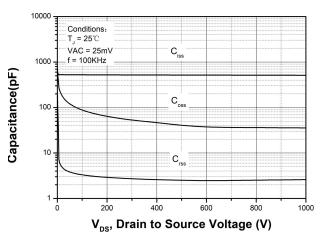
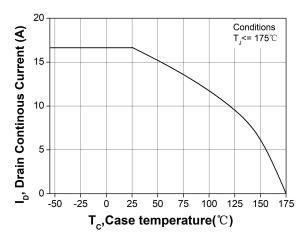


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1000V)

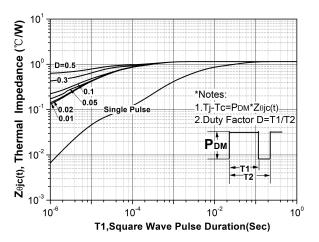
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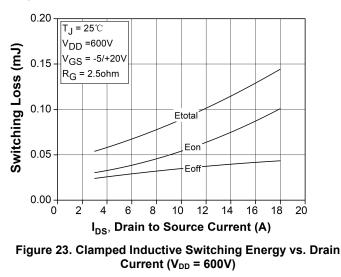
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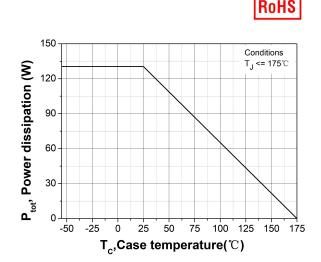
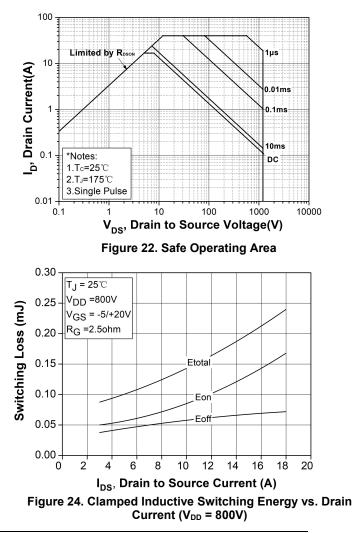
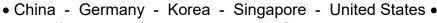


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature





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Τ.

= 25°C

= 800V

V<sub>GS</sub> = -5/+20V

= 10A

0.30

0.25

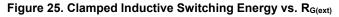
0.20

0.15

#### Switching Loss (mJ) 0.10 0.05 0.00 5 10 15 20 25 0

Eto

R<sub>G</sub>, Gate Resistance (ohm)



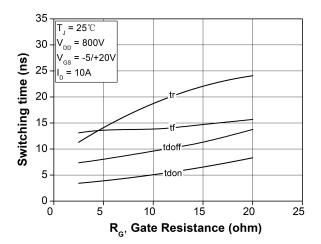
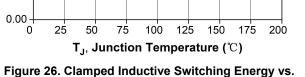


Figure 27. Switching Times vs. R<sub>G(ext)</sub>



0.30

0.25

0.20

0.15

0.10

0.05

Switching Loss (mJ)

R<sub>G</sub>

V<sub>GS</sub>

= 10A

= 2.5ohm

= 800V

= -5/+20V

Figure 26. Clamped Inductive Switching Energy vs. Temperature

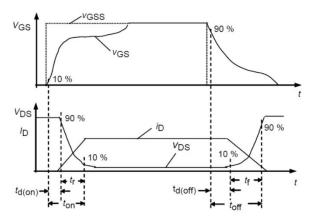


Figure 28. Switching Times Definition





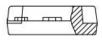
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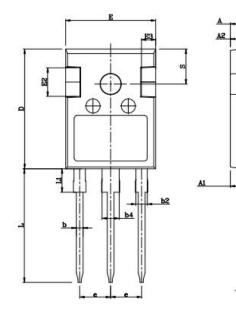


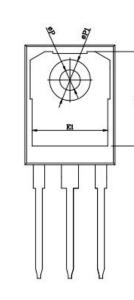
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### **Mechanical Dimensions TO-247AD**







C

#### COMMON DIMENSIONS

| SYMBOL - | mm                 |       |       |  |
|----------|--------------------|-------|-------|--|
|          | Min                | Nom   | Max   |  |
| А        | 4.80               | 5.00  | 5.20  |  |
| Al       | 2.23               | 2.41  | 2.59  |  |
| A2       | 1.85               | 2.00  | 2.15  |  |
| b        | 1.11               | 1.21  | 1.36  |  |
| b2       | 1.91               | 2.01  | 2.21  |  |
| b4       | 2.91               | 3.01  | 3.21  |  |
| с        | 0.51               | 0.61  | 0.75  |  |
| D        | 20.80              | 21.00 | 21.30 |  |
| DI       | 16.25              | 16.55 | 16.85 |  |
| Е        | 15.50              | 15.80 | 16.10 |  |
| El       | 13.00              | 13.26 | 13.56 |  |
| E2       | <mark>4.8</mark> 0 | 5.00  | 5.20  |  |
| E3       | 2,30               | 2.50  | 2.70  |  |
| e        | 5.44BSC            |       |       |  |
| L        | 19.82              | 19.92 | 20.22 |  |
| L1       | 3.94               | 4,12  | 4.30  |  |
| ØP       | 3.40               | 3.60  | 3.80  |  |
| ØP1      | 7.08               | 7.19  | 7.30  |  |
| S        | 6.15BSC            |       |       |  |

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